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FDB52N20 N-Channel UniFETTM MOSFET 200 V, 52 A, 49 mΩ

Features

- + $R_{DS(on)}$ = 49 m Ω (Max.) @ V_{GS} = 10 V, I_D = 26 A
- Low Gate Charge (Typ. 49 nC)
- Low C_{rss} (Typ. 66 pF)
- 100% Avalanche Tested

Applications

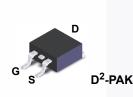
- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

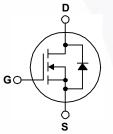




Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FDB52N20	Unit
V _{DSS}	Drain-Source Voltag	200	V	
ID	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	52 33	A A
I _{DM}	Drain Current	- Pulsed (Note 1)	208	А
V _{GSS}	Gate-Source voltage	±30	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2520	mJ
I _{AR}	Avalanche Current (Note 1)		52	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		35.7	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power Dissipation	wer Dissipation (T _C = 25°C) - Derate Above 25°C		W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FDB52N20	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.35	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient (1 in ² Pad of 2-oz Copper), Max.	40	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	

FDB52N2
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I-Channel
UniFET TM
MOSFET

		Package	Packing Method	Reel Size	Ta	pe Width	Qu	antity	
		D ² -PAK	² -PAK Tape and Reel 330 mm		24 mm		800 units		
Electric	al Char	acteristics T _c = 2	25°C unless o	otherwise noted.					
Symbol		Parameter		Conditions		Min.	Тур.	Max	Unit
Off Charac	teristics								<u> </u>
BV _{DSS}	Drain-Sou	rce Breakdown Voltage	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		I _D = 2	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C			0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current			V _{DS} = 200 V, V _{GS} = 0 V V _{DS} = 160 V, T _C = 125°C				1 10	μΑ μΑ
I _{GSSF}	Gate-Body	Leakage Current, Forwa	ard V _{GS} =	30 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body	Leakage Current, Reve	rse V _{GS} =	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Charac	teristics								
V _{GS(th)}	Gate Threshold Voltage		V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} =	V _{GS} = 10 V, I _D = 26 A			0.041	0.049	Ω
9 _{FS}	Forward Transconductance		V _{DS} =	V _{DS} = 40 V, I _D = 26 A			35		S
Dynamic C	haracterist	ics							
C _{iss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance			$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1.0 MHz			2230	2900	pF
C _{oss}			f = 1.0				540	700	pF
C _{rss}							66	100	pF
Switching	Characteris	stics							
t _{d(on)}	Turn-On Delay Time			$V_{DD} = 100 \text{ V}, I_D = 52 \text{ A},$			53	115	ns
t _r	Turn-On R	ise Time	V _{GS} =	V _{GS} = 10 V, R _G = 25 Ω (Note 4)			175	359	ns
t _{d(off)}	Turn-Off D	elay Time					48	107	ns
t _f	Turn-Off F	all Time					29	68	ns
Qg	Total Gate	Charge	V _{DS} =	$V_{DS} = 160 \text{ V}, \text{ I}_{D} = 52 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)			49	63	nC
Q _{gs}	Gate-Sour	ce Charge	V _{GS} =				19		nC
Q _{gd}	Gate-Drair	n Charge					24		nC
Drain-Sour	rce Diode C	haracteristics and Max	imum Rating	gs					
I _S	Maximum	Continuous Drain-Source	e Diode Forw	ard Current				52	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F		de Forward	orward Current				204	Α
V _{SD}	Drain-Sou	rce Diode Forward Voltag	ge V _{GS} =	V _{GS} = 0 V, I _S = 52 A				1.4	V
t _{rr}	Reverse R	ecovery Time		0 V, I _S = 52 A,			162		ns
Q _{rr}	Reverse R	ecovery Charge	dl _F /dt	=100 A/µs			1.3		μC

Notes:

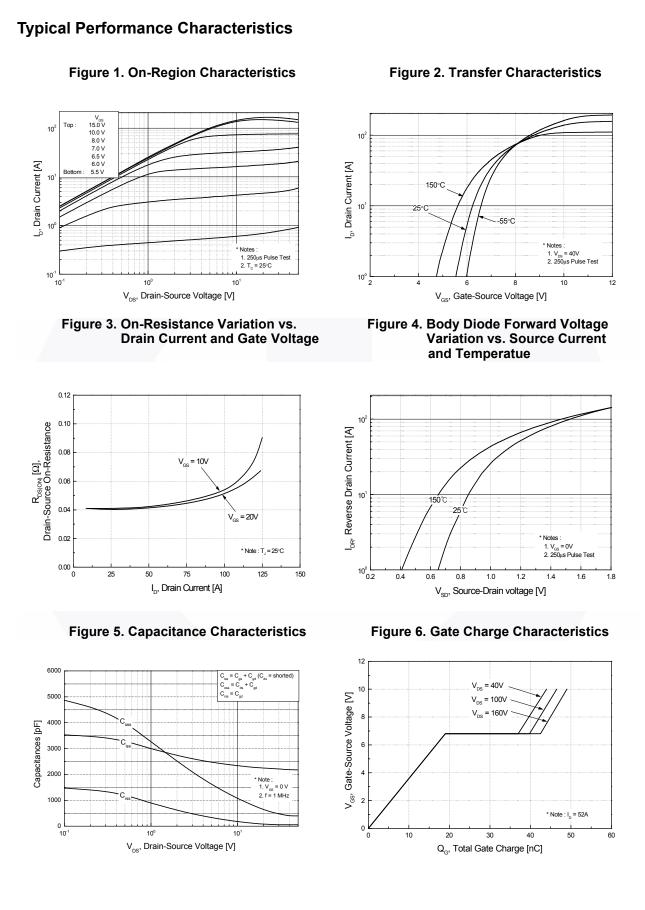
1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 1.4 mH, I_{AS} = 52 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C.

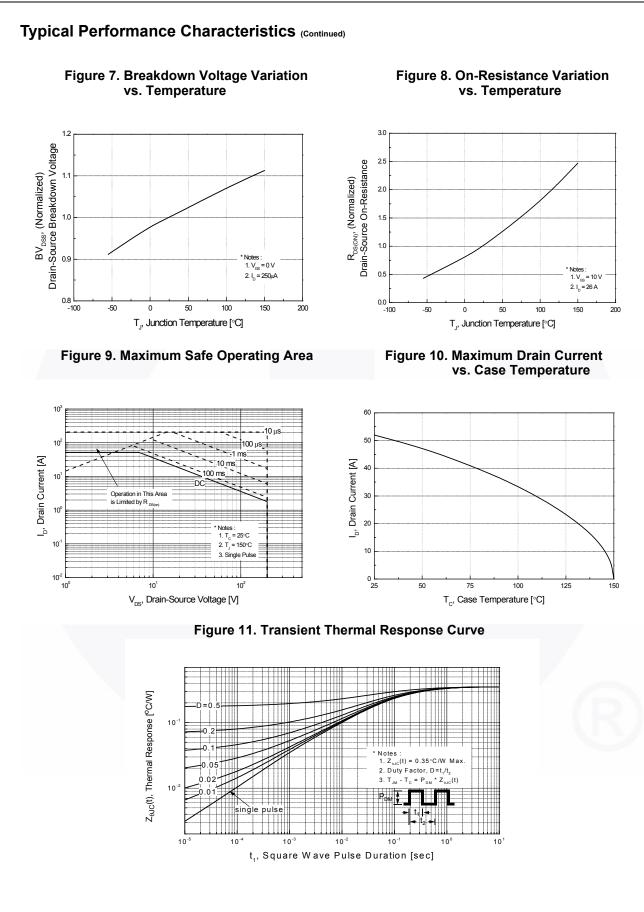
3. I_{SD} \leq 52 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

4. Essentially independent of operating temperature typical characteristics.

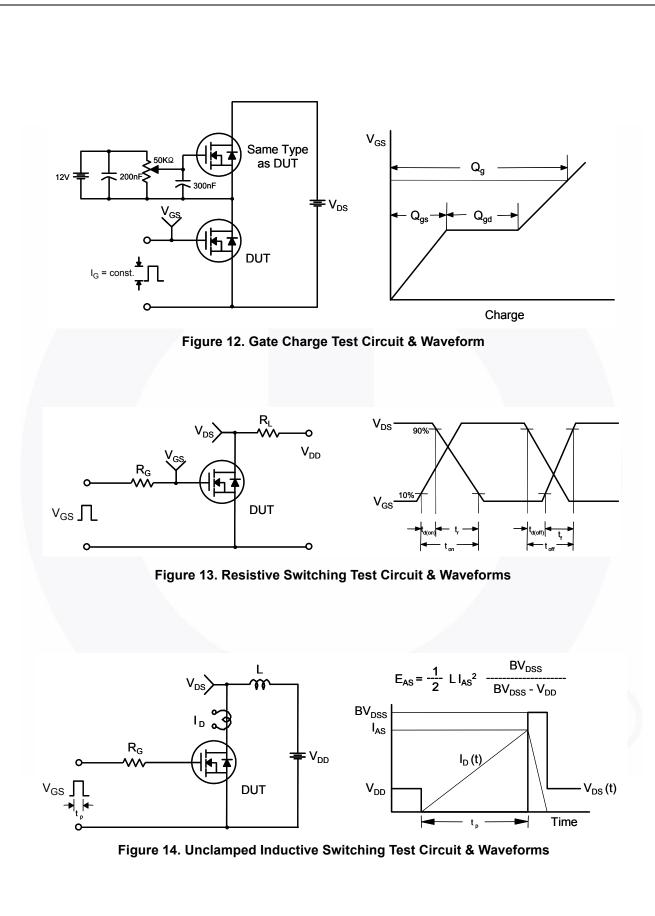
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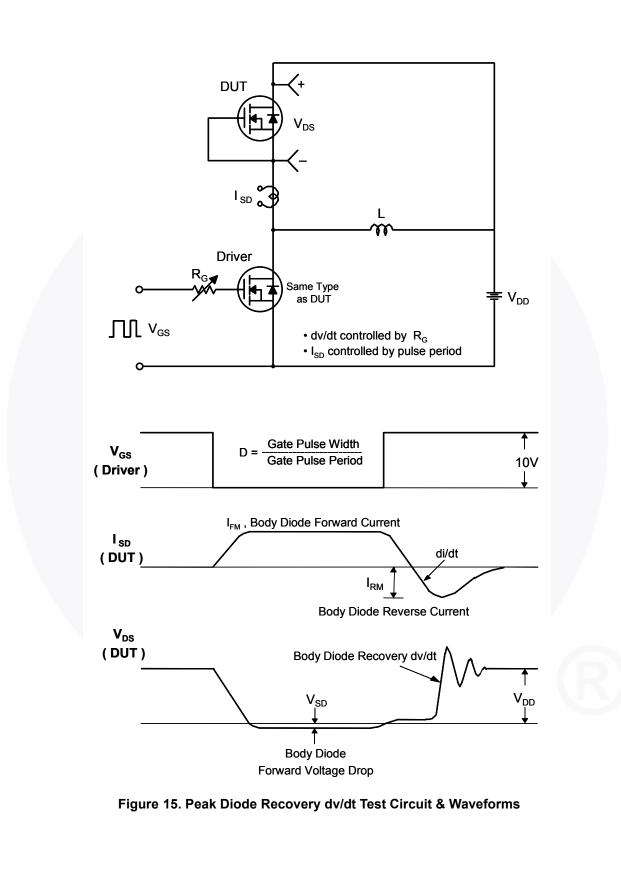


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FDB52N20 — N-Channel UniFETTM MOSFET

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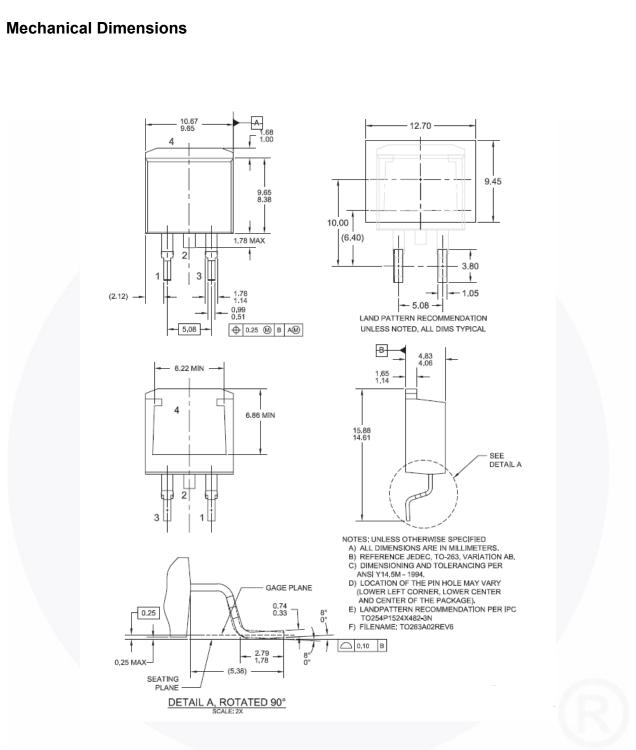


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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